

Common-mode chokes, ring core 4.7 ... 68 mH, 200 ... 700 mA, 60 °C

Series/Type: B82794C0

Date: January 2010



B82794C0

### Common-mode chokes, ring core

<u>SMD</u>

Rated voltage 42 V AC/80 V DC Rated inductance 4.7 mH to 68 mH Rated current 200 mA to 700 mA

#### Construction

- Current-compensated ring core double choke
- Ferrite core
- LCP case (UL 94 V-0)
- Silicone potting
- Bifilar winding

#### **Features**

- Suitable for reflow soldering
- RoHS-compatible

### **Function**

Suppression of asymmetrical interference coupled in on lines, whereas data signals up to some MHz can pass unaffectedly.

### **Applications**

- Telecom applications
- RF equipment

### **Terminals**

- Base material CuSn6
- Layer composition Ni, Sn
- Hot-dipped

### Marking

- Marking on component:
  Manufacturer, ordering code, inductance, graphic symbol, date of manufacture (YYWWD)
- Minimum data on reel:
  Manufacturer, ordering code,
  L value, current, quantity, date of packing

### Delivery mode and packing unit

- 24-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 250 pcs./reel

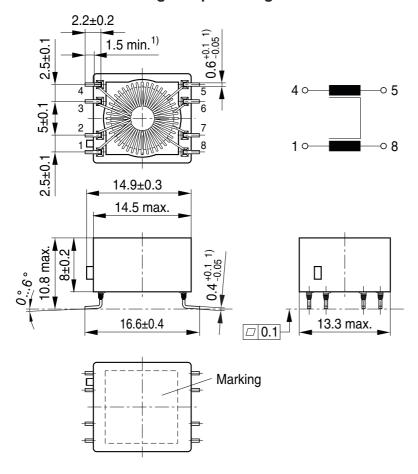


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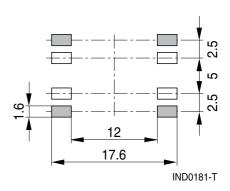
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### Dimensional drawing and pin configuration



### Layout recommendation



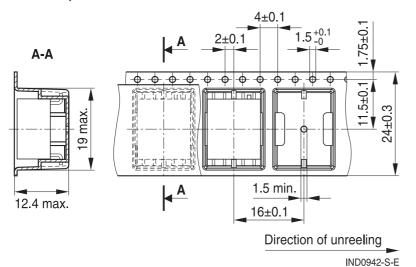
1) Soldering area

IND0180-P-E

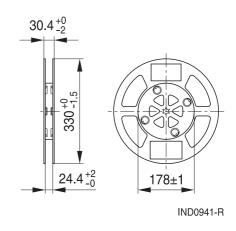
Dimensions in mm

### Taping and packing

Blister tape



### Reel



Dimensions in mm



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# Technical data and measuring conditions

Rated voltage V <sub>R</sub>	42 V AC (50/60 Hz) / 80 V DC			
Rated temperature T <sub>R</sub>	60 °C			
Rated current I <sub>R</sub>	Referred to 50 Hz and rated temperature			
Rated inductance L <sub>R</sub>	Measured with Agilent 4284A at 10 kHz, 50 mV, 20 °C Inductance is specified per winding.			
Inductance tolerance	-30%/+50% at 20 °C			
Inductance decrease ΔL/L <sub>0</sub>	< 10% at DC magnetic bias with I <sub>R</sub> , 20 °C			
Stray inductance L <sub>stray,typ</sub>	Measured with Agilent 4284A at 10 kHz, 50 mV, 20 °C, typical values			
DC resistance R <sub>typ</sub>	Measured at 20 °C, typical values, specified per winding			
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: (245 $\pm$ 5) °C, (3 $\pm$ 0.3) s Wetting of soldering area $\geq$ 95% (to IEC 60068-2-58)			
Resistance to soldering heat	(260 ±5) °C, (10 ±1) s (to IEC 60068-2-58)			
Climatic category	40/125/56 (to IEC 60068-1)			
Storage conditions (packaged)	–25 °C +40 °C, ≤75% RH			
Weight	Approx. 2.7 g			

# **Characteristics and ordering codes**

L <sub>R</sub>	L <sub>stray,typ</sub>	I <sub>R</sub>	R <sub>typ</sub>	V <sub>test</sub>	Ordering code	
mH	nH	mA	mΩ	V DC, 2 s		
4.7	350	700	500	750	B82794C0475N465	
10	450	600	700	750	B82794C0106N465	
28	800	400	1200	750	B82794C0286N465	
47	1200	300	2800	750	B82794C0476N465	
68	1300	200	3400	750	B82794C0686N465	



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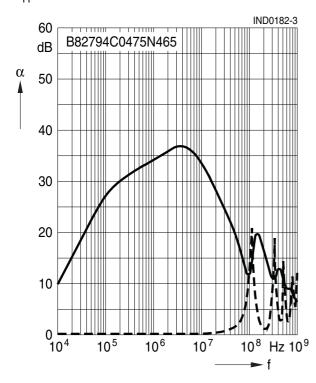
### **SMD**

**Insertion loss**  $\alpha$  (typical values at  $|Z| = 50 \Omega$ , 20 °C)

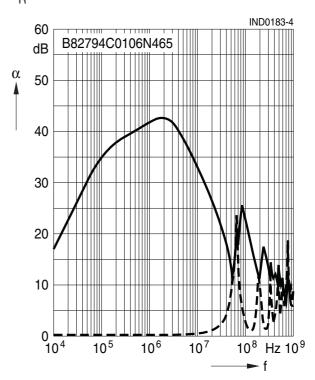
asymmetrical, all branches in parallel (common mode)

- - - - - - symmetrical (differential mode)

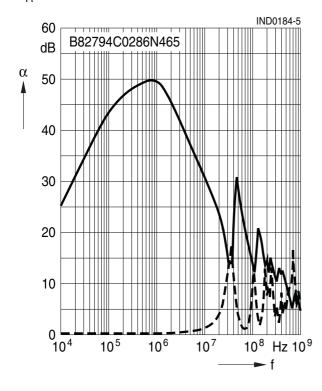
$$L_{R} = 4.7 \text{ mH}$$



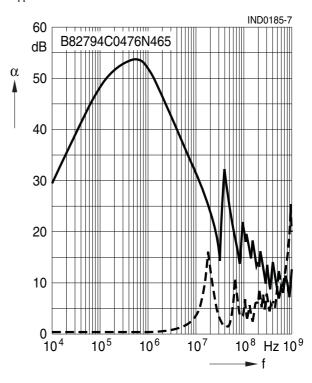
$$L_R = 10 \text{ mH}$$



$$L_{R} = 28 \text{ mH}$$



$$L_{B} = 47 \text{ mH}$$



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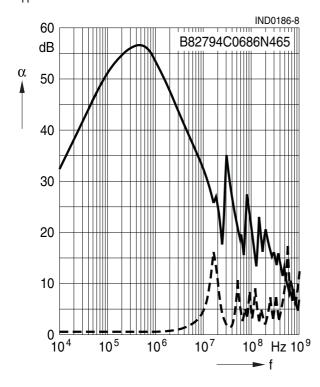
# **SMD**

Insertion loss  $\alpha$  (typical values at |Z| = 50  $\Omega,$  20 °C)

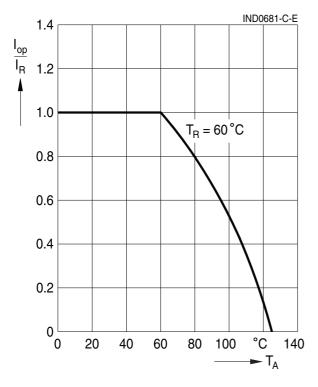
asymmetrical, all branches in parallel (common mode)

- - - - - - symmetrical (differential mode)

 $L_R = 68 \text{ mH}$ 



# Current derating I<sub>op</sub>/I<sub>R</sub> versus ambient temperature





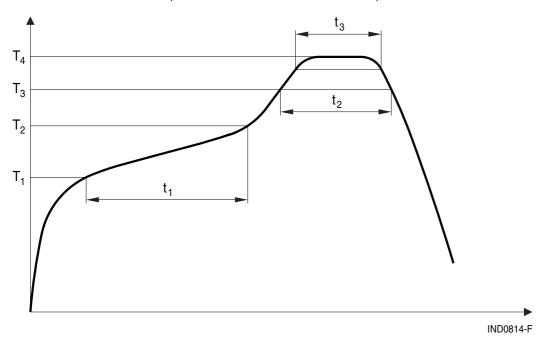
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**SMD** 

# Recommended reflow soldering curve

Pb-free solder material (based on JEDEC J-STD 020C)



T <sub>1</sub>	T <sub>2</sub>	T <sub>3</sub>	T <sub>4</sub>	t <sub>1</sub>	t <sub>2</sub>	t <sub>3</sub>
°C	°C	°C	°C	s	s	S
150	200	217	245	< 110	< 90	< 30 @ T <sub>4</sub> –5 °C

Time from 25 °C to T<sub>4</sub>: max 300 s Maximal numbers of reflow cycles: 3



### **Cautions and warnings**

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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The following applies to all products named in this publication:

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